

AMPMODU | AMPMODU IV/V

TE Internal #: 2-534267-8 PCB Mount Receptacle, Vertical, Board-to-Board, 46 Position, 2.54 mm [.1 in] Centerline, Gold, Through Hole - Solder, Signal, Black, AMPMODU IV/V

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Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Receptacle

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: **46**

Number of Rows: 2

Features

Product Type Features

Applied Pressure

PCB Connector Assembly Type

Connector System

Standard

PCB Mount Receptacle

Board-to-Board

Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Stackable	Yes
PCB Mount Orientation	Vertical
Number of Positions	46
Number of Rows	2
Board-to-Board Configuration	Parallel
Electrical Characteristics	
Dielectric Withstanding Voltage (Max)	750 VAC
Insulation Resistance	5000 MΩ
Operating Voltage	333 VAC
Body Features	
Connector Profile	Low
Primary Product Color	Black

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Contact Features

Contact Mating Area Length	2.54 mm[.1 in]
Mating Square Post Dimension	.64 mm[.025 in]
PCB Contact Termination Area Plating Material Thickness	3.81 – 7.62 μm
Contact Shape & Form	Short Point
PCB Contact Termination Area Plating Material	Tin-Lead
Contact Base Material	Phosphor Bronze
Contact Mating Area Plating Material	Gold
Contact Mating Area Plating Material Thickness	.762 μm[30 μin]
Contact Type	Socket
Contact Type Contact Current Rating (Max)	Socket 3 A
Contact Current Rating (Max)	
Contact Current Rating (Max) Termination Features	3 A
Contact Current Rating (Max) Termination Features Rectangular Termination Post & Tail Thickness	3 A .2 mm[.008 in]
Contact Current Rating (Max) Termination Features Rectangular Termination Post & Tail Thickness Rectangular Termination Post & Tail Width	3 A .2 mm[.008 in] .7 mm[.028 in]

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Mating Alignment	Without
PCB Mount Retention	Without
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount
Housing Features	
Mating Entry Location	Bottom & Top
Centerline (Pitch)	2.54 mm[.1 in]
Housing Material	Polyester - GF
Dimensions	
Connector Height	6.2 mm[.245 in]
Connector Height Row-to-Row Spacing	6.2 mm[.245 in] 2.54 mm[.1 in]
Row-to-Row Spacing	2.54 mm[.1 in]
Row-to-Row Spacing Stack Height	2.54 mm[.1 in] 2.29 mm[.09 in]

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Operating Temperature Range	-65 – 125 °C[-85 – 257 °F]
Operation/Application	
Solder Process Feature	Board Standoff
Circuit Application	Signal
Industry Standards	
Approved Standards	CSA LR7189, UL E28476
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	9
Packaging Type	Box, Tube
Product Compliance For compliance documentation, visit the product page on TE.com>	
EU RoHS Directive 2011/65/EU	Not Compliant
EU ELV Directive 2000/53/EC	Compliant with Exemptions
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235)

Candidate List Declared Against: JUNE

2023 (235)

SVHC > Threshold:

Pb (13% in Component Part)

Article Safe Usage Statements:

Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.

Not Low Halogen - contains Br or Cl > 900 ppm.

Wave solder capable to 240°C

Halogen Content

Solder Process Capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

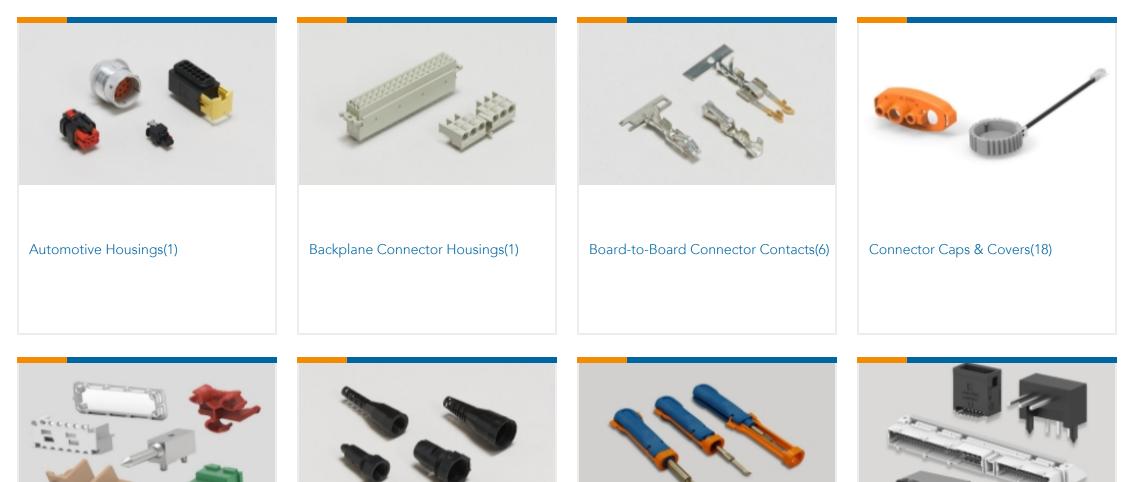
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Compatible Parts



Also in the Series | AMPMODU IV/V

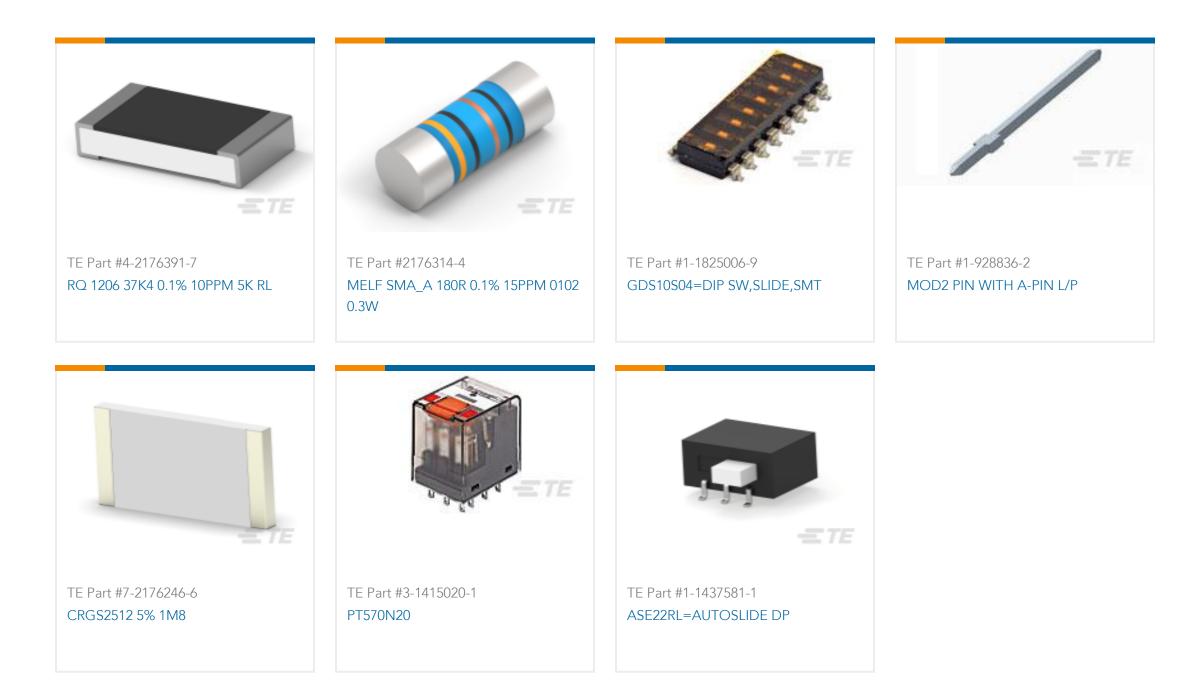


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Connector Hardware(14)	Connector Strain Relief(3)	Insertion & Extraction Tools(4)	PCB Headers & Receptacles(931)
			And the second
Rectangular Connector Housings(5)	Standard Rectangular Connectors(8)	Wire-to-Board Connector Assemblies & Housings(445)	Wire-to-Board Connector Contacts (317)

Customers Also Bought

PCB Mount Receptacle, Vertical, Board-to-Board, 46 Position, 2.54 mm [.1 in] Centerline, Gold, Through Hole - Solder, Signal, Black, AMPMODU IV/V





Documents

Product Drawings 46 MODIV VRT DR OE 100/125

English

CAD Files **Customer View Model** ENG_CVM_2-534267-8_AB.2d_dxf.zip

English

3D PDF

English

Customer View Model

ENG_CVM_2-534267-8_AB.3d_igs.zip

English

Customer View Model

ENG_CVM_2-534267-8_AB.3d_stp.zip

English

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Product Specifications Application Specification

English